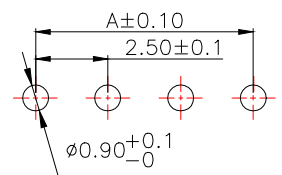
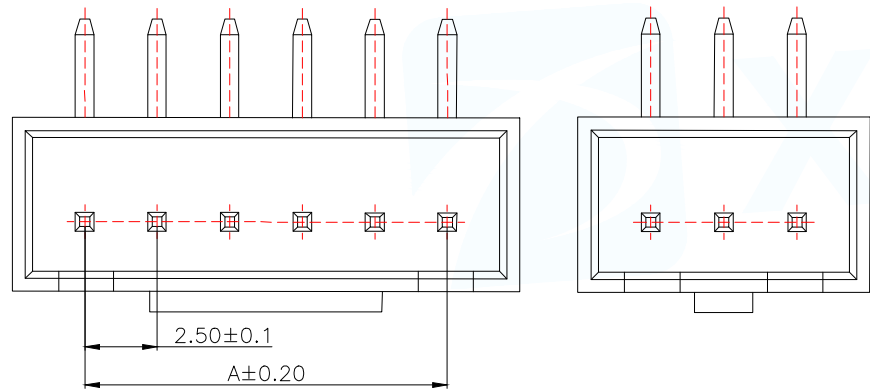


Part No	Pin	A	B
WAFER-HA2.54-2PWZ	2	2.50	7.50
WAFER-HA2.54-3PWZ	3	5.00	10.00
WAFER-HA2.54-4PWZ	4	7.50	12.50
WAFER-HA2.54-5PWZ	5	10.00	15.00
WAFER-HA2.54-6PWZ	6	12.50	17.50
WAFER-HA2.54-7PWZ	7	15.00	20.00
WAFER-HA2.54-8PWZ	8	17.50	22.50
WAFER-HA2.54-9PWZ	9	20.00	25.00
WAFER-HA2.54-10PWZ	10	22.50	27.50
WAFER-HA2.54-11PWZ	11	25.00	30.00
WAFER-HA2.54-12PWZ	12	27.50	32.50
WAFER-HA2.54-13PWZ	13	30.00	35.00
WAFER-HA2.54-14PWZ	14	32.50	37.50
WAFER-HA2.54-15PWZ	15	35.00	40.00
WAFER-HA2.54-16PWZ	16	37.50	42.50
WAFER-HA2.54-17PWZ	17	40.00	45.00
WAFER-HA2.54-18PWZ	18	42.50	47.50
WAFER-HA2.54-19PWZ	19	45.00	50.00
WAFER-HA2.54-20PWZ	20	47.50	52.50



SUGGESTED PCB LAYOUT
(COMPONENT SIDE)

- 技术要求:
1. 塑件材料:PA66(UL-94V-0)
 2. 接触件:黄铜镀锡
 3. 接触电阻:≤10mΩ
 4. 绝缘电阻:≥100MΩ
 5. 额定电压:250V AC DC
 6. 额定电流:2.0A AC DC
 7. 耐压:能承受1000V AC/Minute
 8. 工作温度:-25°~+85°
 9. 可焊性试验:浸锡面积≥95%温度235±5°, 时间2.5±0.5秒
 10. 铅和镉等六大有害物质含量要符合环保要求。

2	端子Contact	黄铜	N*1	电镀(锡):整个表面镀底镍 30u"MIN,再镀锡80u"MIN
1	基座Wafer	PA66(UL94 V-0)	1	白色
序号	名称	材料	数量	备注
MANUFACTURE DWG		东莞市讯普电子科技有限公司 DongGuan XunPu Electronics Co.,Ltd		
UNLESS OTHERWISE SPECIFIED TOLERANCES			TITLE: WAFER XHB2.54MM 带扣 弯针	
DECIMALS: .X±0.20			PAR	WAFER-HA2.54-NPWZ
ANGLES: ±2'			DWN	
.XX±0.10			CHKD	
.XXX±0.05		APVD		
		SCALE:1:1	UNIT:MM	
		CUSTOMER COPY	SIZE:A4	SHEET:1F1
				REV:A